

Evaluation Board for Single, High Speed Operational Amplifiers (8-Lead, 3 mm × 3 mm LFCSP with Dedicated Feedback Pin)

FEATURES

Enables quick breadboarding/prototyping

User-defined circuit configuration

Edge-mounted SMA connector provisions

Easy connection to test equipment and other circuits

GENERAL DESCRIPTION

The EB-O8CP33-1Z is designed to aid in the evaluation of single, high speed operational amplifiers. The EB-O8CP33-1Z is a bare board (that is, there are no components soldered to the board) that enables users to quickly prototype a variety of operational amplifier circuits, which minimizes risk and reduces time to market. The EB-O8CP33-1Z evaluation board supports any of the Analog Devices, Inc., single, high speed operational amplifiers in 8-pin, 3 mm × 3 mm lead frame chip scale packages (LFCSP) with a dedicated feedback pin.

Figure 1 shows the component side and circuit side of the evaluation board. Figure 2 shows the evaluation board schematic.

The 4-layer evaluation board accepts edge-mounted SMA connectors on both inputs and outputs, which allows efficient and quick connection to test equipment or other circuitry.

The board ground plane, component placement, and power supply bypassing have been optimized for maximum circuit flexibility and performance. The evaluation board uses a variety of SMT component case sizes: 0402, 0508, 0603, and 7343.

Figure 3 and Figure 5 show the evaluation board assembly drawings. The metal layout pattern for connecting the board to the op amp and to the supporting circuitry is shown in Figure 4 and Figure 6.

DIGITAL PICTURE OF EVALUATION BOARD

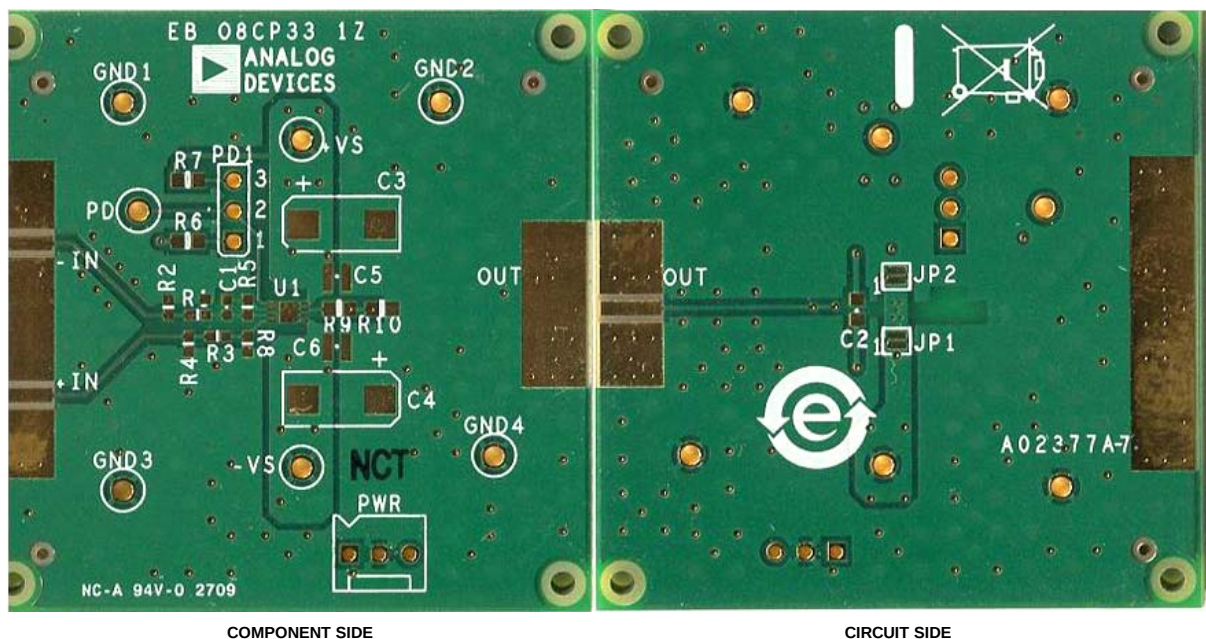


Figure 1. EB-O8CP33-1Z Component and Circuit Side of PCB

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REVISION HISTORY

1/10—Revision 0: Initial Version

EVALUATION BOARD SCHEMATIC

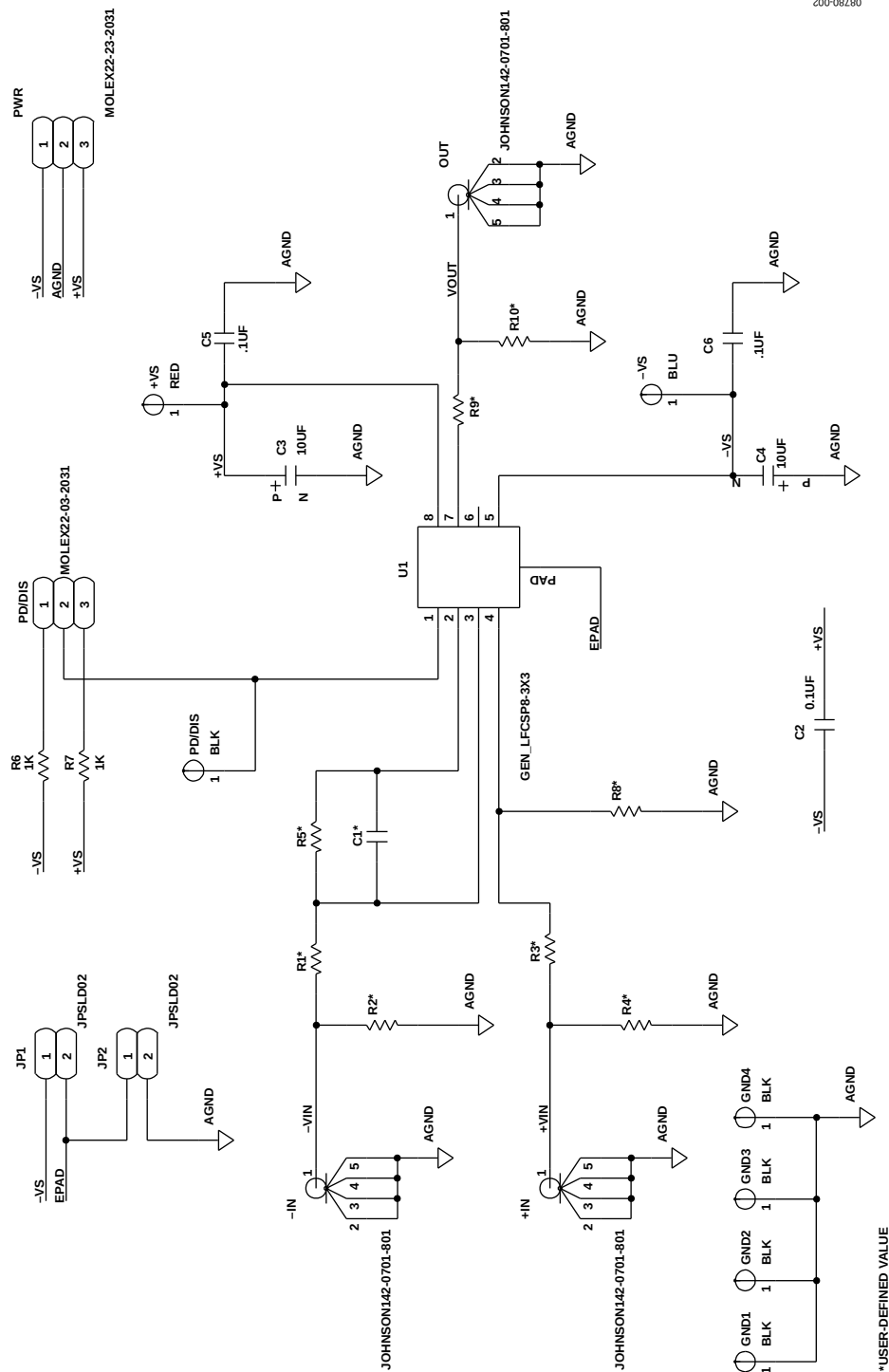


Figure 2. Universal Evaluation Board Schematic

ASSEMBLY DRAWING AND BOARD LAYOUT

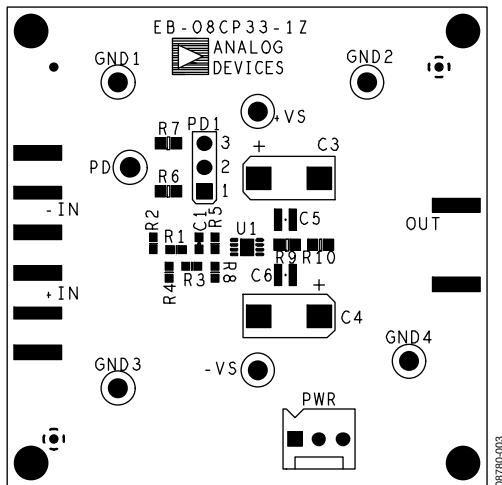


Figure 3. Board Assembly Drawing, Component Side

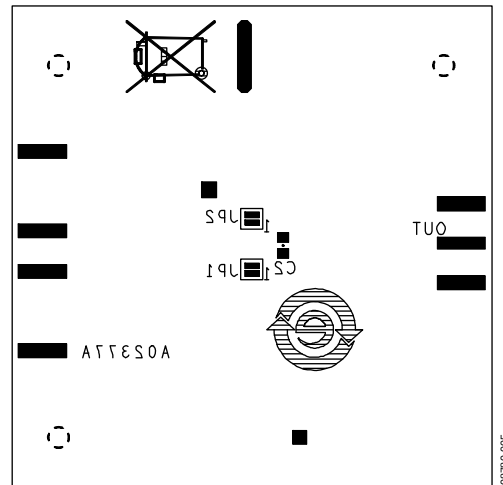


Figure 5. Board Assembly Drawing, Circuit Side

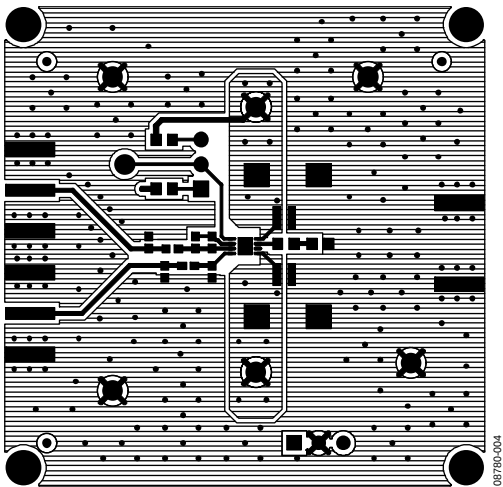


Figure 4. Board Layout Pattern, Component Side

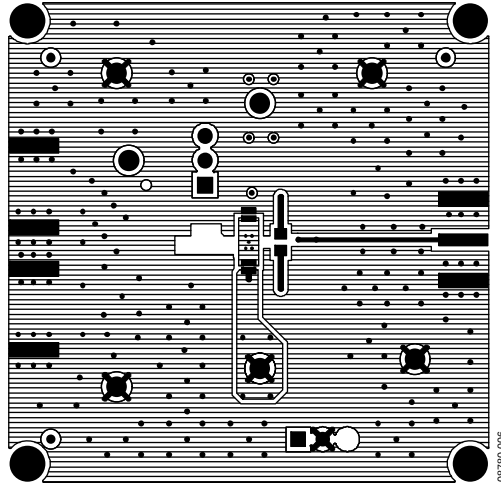


Figure 6. Board Layout Pattern, Circuit Side

ESD CAUTION

**ESD (electrostatic discharge) sensitive device.**

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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